

Customer No.: 31561
Application No.: 10/711,378
Docket NO.: 13816-US-PA

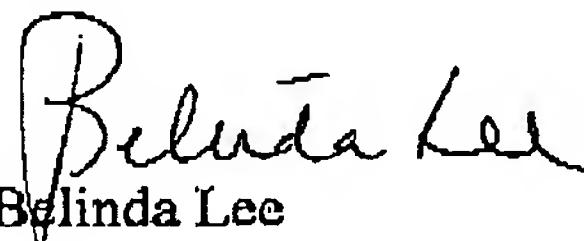
REMARKS

In response to the Office Action, mailed on November 10, 2005, a complete listing of all of the claims is presented herewith. Applicant would like to elect Species 1, claims 1-9, drawn to a mechanism for compressing chips of Fig. 2. Please withdraw Species 2, claims 10-17, drawn to a mechanism for compressing chips of Fig. 3, without waiver, prejudice or disclaimer. Currently, claim 1 is generic.

If the Examiner believes that a telephone conference would expedite the examination of the above-identified patent application, the Examiner is invited to call the undersigned.

Date : Dec. 9, 2005

Respectfully submitted,


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